

**Atty Docket No.:** M4065.067/P067

**Applicant:** Warren Farnworth et al.

**Serial No.:** 09/118,080

**Filing Date:** July 17, 1998

**Title:** TAPED SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURE

**Documents Filed:** Information Disclosure Statement, Form PTO 1449, and 8 References

**Sender's Initials:** MJT/MC/tas

**Date:** August 19, 1998

PATENT  
Docket No.: M4065.067/P067

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent Application of  
Warren M. Farnworth

Serial No.: 09/118,080

Art Unit: 2811

Filed: July 17, 1998

Examiner: Not Yet Assigned

For: TAPED SEMICONDUCTOR DEVICE AND METHOD OF  
MANUFACTURE

Assistant Commissioner for Patents  
Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT (IDS)

Dear Sir:

Pursuant to 37 C.F.R. 1.56, the attention of the Patent and Trademark Office is hereby directed to the references listed on the attached PTO-1449. A copy of each reference is attached. It is respectfully requested that the information be expressly considered during the prosecution of this application, and that the references be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

- 1. This Information Disclosure Statement is being filed within three months of the U.S. filing date OR within three months of the date of entry of the national stage as set forth in 37 C.F.R. 1.491, OR before the mailing date of a first Office Action on the merits, whichever event occurs last. No certification or fee is required. 37 C.F.R. 1.97(b).
- 2. This Information Disclosure Statement is being filed more than three months after the U.S. filing date, OR more than three months after the date of entry of the national stage, AND after the mailing date of the first Office Action on the merits, whichever occurs first, but before the mailing date of a Final rejection or Notice of Allowance. 37 C.F.R. 1.97(c).

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— a. I hereby certify that each item or information contained in this Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement.  
37 C.F.R. 1.97(e)(1).

— b. I hereby certify that no item of information in this Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to my knowledge after making reasonable inquiry, was known to any individual designated in 37 C.F.R. 1.56(c) more than three months prior to the filing of this Information Disclosure Statement. 37 C.F.R. 1.97(e)(2).

— c. Attached is our check in the amount of \_\_\_\_\_ in payment of the fee under 37 C.F.R. 1.17(p). Please charge any fee deficiencies, or credit any overpayment, to Deposit Account No. 04-1073 as needed to ensure consideration of the Information Disclosure Statement. Two duplicate copies of this paper are attached.

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37 C.F.R 1.97(e)(1).

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4. Translations of the non-English language references are enclosed.

full

partial

summary/abstract

5. A copy of a foreign application communication from a related foreign application discussing the relevancy of the references is attached.

Dated: August 18, 1998

Respectfully submitted,

By 

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**INFORMATION DISCLOSURE CITATION  
IN AN APPLICATION**  
*(Use several sheets if necessary)*

Docket Number (Optional) M4065.067/

Application Number

Applicant(s)  
Warren M. Farnworth

**Filing Date**

July 17, 1998

Group Art Unit 2814  
~~Not Yet Assigned~~

## U.S. PATENT DOCUMENTS

## FOREIGN PATENT DOCUMENTS

**OTHER DOCUMENTS** *(Including Author, Title, Date, Pertinent Pages, Etc.)*

AC	E	L Platform SMT Printers For The Real World Brochure
	F	DEK 265 Next Generation High Performance Surface Mount Screen Print Brochure
AC	G	Technical Data Sheet: Master Bond Polymer System EP31
	H	Master Bond Problem Solver Brochure

**EXAMINER**

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**EXAMINER:** Initial if considered. Include copy

**DATE CONSIDERED**

10/8/00

**EXAMINER:** Initial if citation considered, whether or not citation is in conformance with MPEP Section 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.